

TE Internal #: 2040910-1

Double Data Rate (DDR), Vertical Module Orientation, 200 Position,

.6 mm [.024 in] Centerline, Gold, Box / Tray, Power, SO DIMM

Sockets

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Connectors > Socket Connectors > Memory Sockets > SO DIMM Sockets > DDR2 SO DIMM Sockets



DRAM Type: Double Data Rate (DDR)

Module Orientation: Vertical Number of Positions: 200

Centerline (Pitch): .6 mm [ .024 in ] Row-to-Row Spacing: 8.6 mm [ .338 in ]

All DDR2 SO DIMM Sockets (30)

## **Features**

Product Type Features	
Connector System	Cable-to-Board
Connector & Contact Terminates To	Printed Circuit Board
DRAM Type	Double Data Rate (DDR)
Configuration Features	
Number of Bays	2
Number of Keys	1
Number of Rows	2
Module Orientation	Vertical
Number of Positions	200
Electrical Characteristics	
DRAM Voltage	2.5 V
Signal Characteristics	
SGRAM Voltage	1.8 V
Body Features	
Ejector Location	Both Ends
Latch Material	High Temperature Thermoplastic

Both Ends

Retention Post Location



Latch Plating Material	Tin
Module Key Type	Offset Right
Ejector Type	Standard
Contact Features	
Memory Socket Type	Memory Card
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Current Rating (Max)	.5 A
Contact Mating Area Plating Material	Gold
Termination Features	
Insertion Style	Cam-In
Termination Method to PCB	Surface Mount
Mechanical Attachment	
Mating Alignment Type	Standard Keying
PCB Mount Retention	With
PCB Mount Retention Type	Solder Tail
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	Thermoplastic
Centerline (Pitch)	.6 mm[.024 in]
Dimensions	
Row-to-Row Spacing	8.6 mm[.338 in]
Usage Conditions	
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]
Operation/Application	
Circuit Application	Power
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	24
Packaging Method	Box, Tray



# **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**



# Customers Also Bought

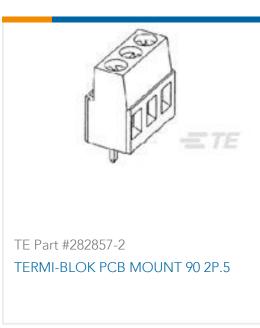






















### **Documents**

## **Product Drawings**

SEMI-HARD TRAY ASSY DDR 200P VERTICAL

English

### **CAD Files**

**Customer View Model** 

ENG\_CVM\_CVM\_2040910-1\_D.2d\_dxf.zip

English

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_2040910-1\_D.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2040910-1\_D.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

**Product Specifications** 

Double Data Rate (DDR), Vertical Module Orientation, 200 Position, .6 mm [.024 in] Centerline, Gold, Box / Tray, Power, SO DIMM Sockets



# DDR S.O.DIMM Socket 200 Position Vertical type

Japanese

**Product Specification** 

Japanese